# Wide Input Voltage Range 10 mA Ultra-Low Iq, High **PSRR Linear Regulator with Adjustable Output Voltage**

The NCP786A is high-performance linear regulator, offering a very wide operating input voltage range of up to 450 V DC, with an output current of up to 10 mA. Ideal for high input voltage applications such as industrial and home metering, home appliances. The NCP786A family offers ±3% initial accuracy, extremely high-power supply rejection ratio and ultra-low quiescent current. The NCP786A family is optimized for high-voltage line and load transients, making them ideal for harsh environment applications. The output voltage can be set by resistor divider in range from 1.27 V up to 15 V. DFN6 5x6 Pb-free package with high allowable power dissipation keep small footprint at space sensitive applications.

#### **Features**

• Wide Input Voltage Range:

DC: Up to 450 V

AC: 85 V to 260 V (half–wave rectifier and 4.7 µF capacitor)

- 10 mA Guaranteed Output Current
- Ultra Low Quiescent Current: Typ. 10  $\mu$ A ( $V_{OUT} \le 15 \text{ V}$ )
- ±5% Accuracy Over Full Load, Line and Temperature Variations
- Ultra-high PSRR: 70 dB at 60 Hz, 90 dB at 100 kHz
- Stable with Ceramic Output Capacitor 2.2 μF MLCC
- Thermal Shutdown and Current Limit Protection
- Available in DFN6 5x6 Package
- This is a Pb-Free Device

#### **Typical Applications**

- Industrial Applications, Home Appliances
- Home Metering / Network Application
- Off-line Power Supplies



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# **MARKING DIAGRAM**



**DFN6 5x6** ST SUFFIX CASE 506DV



786A = Specific Device Marking XXX = Voltage Version

(see page 6)

= Assembly Location

= Wafer Lot

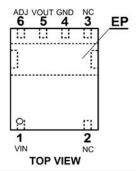
= Year

WW = Work Week

= Pb-Free Package

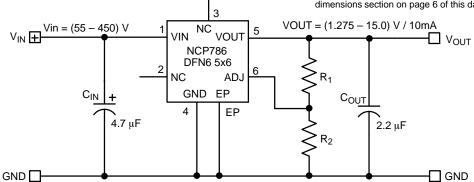
(Note: Microdot may be in either location)

#### PIN CONNECTIONS



#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.



**Figure 1. Typical Applications** 

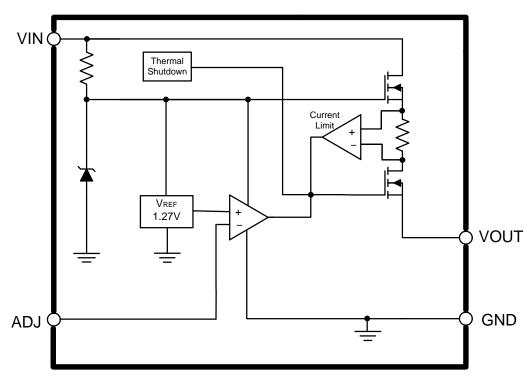


Figure 2. Simplified Internal Block Diagram

**Table 1. PIN FUNCTION DESCRIPTION** 

Pin No.	Pin Name	Description		
1	VIN	Supply Voltage Input. Connect 4.7 μF capacitor from VIN to GND.		
2	NC	Not connected.		
3	NC	Not connected.		
4	GND	Ground connection.		
5	VOUT	Regulator Output. Connect 2.2 μF or higher MLCC capacitor from VOUT to GND.		
6	ADJ	ADJ pin for output voltage setting via resistors divider.		
EP	EP	EP should be connected to GND potential.		

**Table 2. ABSOLUTE MAXIMUM RATINGS** 

Rating	Symbol	Value	Unit
Input Voltage (Note 1)	V <sub>IN</sub>	-0.3 to 700	V
Output Voltage	V <sub>OUT</sub>	-0.3 to 18	V
Maximum Junction Temperature	$T_{J(MAX)}$	85	°C
Storage Temperature	T <sub>STG</sub>	-55 to 150	°C
ESD Capability, Human Body Model (All pins except HV pin no.1) (Note 2)	ESD <sub>HBM</sub>	2000	V
ESD Capability, Machine Model (Note 2)	ESD <sub>MM</sub>	200	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Peak 650 V max 1 ms non repeated for 1 s

- 2. This device series incorporates ESD protection and is tested by the following methods: ESD Human Body Model tested per AEC-Q100-002 (EIA/JESD22-A114) ESD Machine Model tested per AEC-Q100-003 (EIA/JESD22-A115)

  - Latch-up Current Maximum Rating tested per JEDEC standard: JESD78.

### **Table 3. THERMAL CHARACTERISTICS**

Rating	Symbol	Value	Unit
Thermal Characteristics, DFN6 Thermal Resistance, Junction-to-Air JEDEC 51.3, One side, 600 sq mm PCB	$R_{ hetaJA}$	82	°C/W

Table 4. ELECTRICAL CHARACTERISTICS NCP786A Adj. ( $-40^{\circ}C \le T_{J} \le 85^{\circ}C$ ; V<sub>IN</sub> = 340 V; I<sub>OUT</sub> = 100 μA, C<sub>IN</sub> = 4.7 μF, C<sub>OUT</sub> = 10 μF, unless otherwise noted. Typical values are at  $T_{J}$  = +25°C.) (Note 3)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit	
Operating Input Voltage DC		$V_{IN}$	55		450	V	
Maximum output voltage	$\begin{array}{l} -40^{\circ}C \leq T_{J} \leq 85^{\circ}C, \ lout = 100 \ \mu A, \\ 55 \ V \leq Vin \leq 450 \ V \end{array}$	Voutmax		15		V	
Reference Voltage Accuracy	$T_J = 25^{\circ}C$ , lout = 100 $\mu$ A, 55 V $\leq$ Vin $\leq$ 450 V		$V_{REF}$	-3%	1.275	+3%	V
	$-40^{\circ}$ C $\leq$ T <sub>J</sub> $\leq$ 85 $^{\circ}$ C, lout = 100 $\mu$ A, 55 V $\leq$ Vin $\leq$ 450 V		$V_{REF}$	-5%	1.275	+5%	V
Line Regulation	$V_{IN} = 55 \text{ V to } 450 \text{ V, lout} = 100 \mu\text{A}$		Reg <sub>LINE</sub>	-0.5	0.1	+0.5	%
Load Regulation	$I_{OUT} = 100 \mu A \text{ to } 10 \text{ mA}, \text{ Vin} = 55 \text{ V}$		Reg <sub>LOAD</sub>	-1.0	0.7	+1.0	%
Maximum Output Current	55 V ≤ Vin ≤ 450 V, (Note 4)	I <sub>OUT</sub>	11			mA	
Quiescent Current	I <sub>OUT</sub> = 0, 55 V ≤ Vin ≤ 450 V		I <sub>GND</sub>		10	15	μΑ
Ground current	55 V ≤ Vin ≤ 450 V, (Note 4) 0 < I <sub>OUT</sub> ≤ 10 mA					25	μΑ
ADJ Pin current					150		nA
Power Supply Rejection Ratio	$ \begin{array}{ll} \mbox{Vin} = 340 \mbox{ VDC +1 Vpp modulation,} & \mbox{f} = 1 \mbox{ kHz} \\ \mbox{lout} = 100  \mu\mbox{A} \\ \end{array} $		PSRR		65		dB
Noise	$f$ = 10 kHz to 1 MHz Vin = 340 VDC, lout = 1 mA, $C_{OUT}$ = 10 $\mu F$		V <sub>NOISE</sub>		150		μVrms
Thermal Shutdown Temperature (Note 5)	Temperature increasing from T <sub>J</sub> = +25°C		T <sub>SD</sub>		145		°C
Thermal Shutdown Hysteresis (Note 5)	Temperature falling from T <sub>SD</sub>		T <sub>SDH</sub>	-	10	-	°C

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

<sup>3.</sup> Performance guaranteed over the indicated operating temperature range by design and/or characterization production tested at T<sub>J</sub> = T<sub>A</sub> = 25°C. Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.

<sup>4.</sup> Respect to Safe Operating Area

<sup>5.</sup> Guaranteed by design

# TYPICAL CHARACTERISTICS

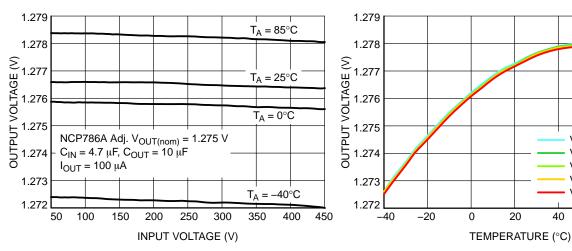


Figure 3. Output Voltage vs. Input Voltage

Figure 4. Output Voltage vs. Temperature

20

 $V_{IN} = 55 V$ 

 $V_{IN} = 150 \text{ V}$ 

 $V_{IN} = 250 \text{ V}$  $V_{IN} = 350 \text{ V}$ 

 $V_{IN} = 450 \text{ V}$ 

60

80

40

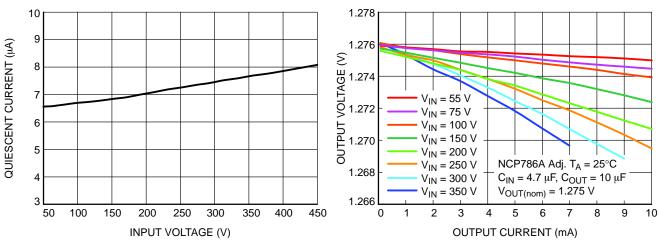


Figure 5. Quiescent Current vs. Input Voltage

Figure 6. Output Voltage vs. Output Current

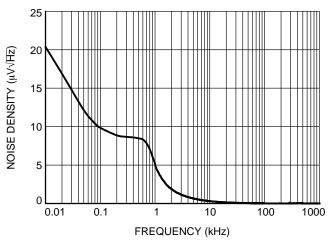
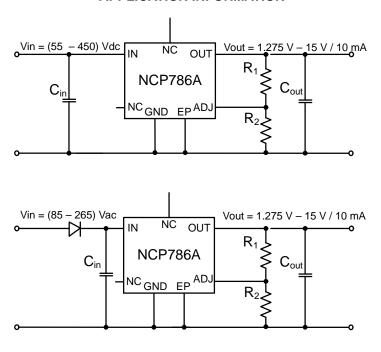


Figure 7. Noise Density vs. Frequency

#### APPLICATION INFORMATION



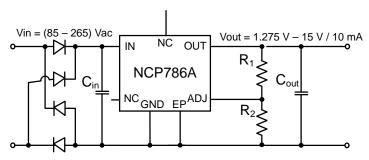


Figure 8. Typical Application Schematics

#### Input Decoupling (C1)

A 4.7  $\mu F$  capacitor either ceramic or electrolytic is recommended and should be connected close to the input pin of NCP786A. Higher value 4.7  $\mu F$  is necessary to keep the input voltage above the required minimum input voltage at full load for AC voltage as low as 85 V with half wave rectifier. The capacitor 2.2  $\mu F$  or 1  $\mu F$  could be acceptable for DC input voltage or AC input voltage 235 V  $\pm 20\%$ . There must be assured minimum Input Voltage more than 55 V at input pin of NCP786A regulator in order to keep stable desired output voltage with guaranteed parameters.

#### **Output Decoupling (C2)**

The NCP786A Regulator does not require any specific Equivalent Series Resistance (ESR). Thus capacitors exhibiting ESRs ranging from a few m $\Omega$  up to 0.5  $\Omega$  can be used safely. The minimum decoupling value is 2.2  $\mu$ F. The regulator accepts ceramic chip capacitors as well as tantalum devices or low ESR electrolytic capacitors. Larger values improve noise rejection and especially load transient response.

#### **Layout Recommendations**

Please be sure that the  $V_{IN}$  and GND lines are sufficiently wide. When the impedance of these lines is high, there is a chance to pick up noise or to cause the malfunction of regulator.

Set external components, especially the output capacitor, as close as possible to the circuit, and make leads as short as possible.

#### **Thermal**

As power across the NCP786A increases, it might become necessary to provide some thermal relief. The maximum power dissipation supported by the device is dependent upon board design layout and used package. Mounting pad configuration on the PCB, the board material, and also the ambient temperature affect the rate of temperature rise for the part. This is stating that when the NCP786A has good thermal conductivity through the PCB, the junction temperature will be relatively low with high power dissipation applications.

### **Output Voltage**

The output voltage can be set by using a resistor divider as shown in Figure 1 in range from 1.275 V up to 15 V. The appropriate resistor divider can be found by solving the equation below.

$$V_{OUT} = 1.275 \times \left(1 + \frac{R1}{R2}\right) + \left(I_{ADJ} \times R1\right) \text{ (eq. 1)}$$

The recommended current through the resistor divider is from 1  $\mu A$  to 3  $\mu A$  in order to keep negligible ADJ pin consumption. In this case we can simplify Equation 1 to:

$$V_{OUT} = 1.275 \times \left(1 + \frac{R1}{R2}\right)$$
 (eq. 2)

### **ORDERING INFORMATION**

Part Number	Output Voltage	Marking	Package	Shipping <sup>†</sup>
NCP786ASTADJTBG	Adjustable	ADJ	DFN6 5x6 (Pb–Free)	1000 / Tape & Reel

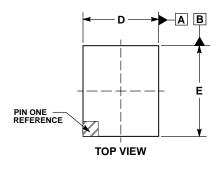
<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### PACKAGE DIMENSIONS

#### DFN6 5x6, 1.27P CASE 506DV **ISSUE O**

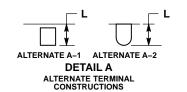
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C SEATING PLANE



**DETAIL A** 

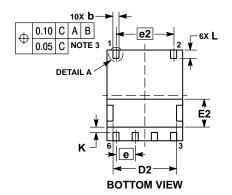
SIDE VIEW



- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETER.
- CONTROLLING DIMENSION: MILLIMETER.
  DIMENSION & APPLIES TO PLATED
  TERMINAL AND IS MEASURED BETWEEN
  0.20 AND 0.25 MM FROM THE TERMINAL TIP.
  COPLANARITY APPLIES TO THE EXPOSED
  PAD AS WELL AS THE TERMINALS.
  FOR DEVICE OPN CONTAINING W OPTION,
  DETAIL & ALTERNATE B-1 AND DETAIL A
  LITERNATE A 1 CONSTRUCTIONS ARE
- ALTERNATE A-1 CONSTRUCTIONS ARE NOT APPLICABLE.

EXPOSED Cu	MOLD CMP	A3
		↑ \
ALTER	NATE B-1	ALTERNATE B-2
	DETA	IL B
	ALTER	
	CONSTRU	CTIONS

	MILLIMETERS				
DIM	MIN	NOM	MAX		
Α	0.80	0.90	1.00		
A1			0.05		
A3		0.20 REF			
b	0.30	0.40	0.50		
D	4.90	5.00	5.10		
D2	4.10	4.20	4.30		
E	5.90	6.00	6.10		
E2	1.75	1.85	1.95		
е	1.27 BSC				
e2	3.81 BSC				
K	0.25				
L	0.45	0.55	0.65		

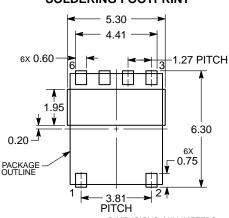


// 0.10 C

 $\triangle$  0.08 C

NOTE 4

#### RECOMMENDED SOLDERING FOOTPRINT\*



**DIMENSIONS: MILLIMETERS** 

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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